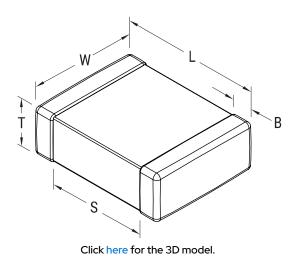


## C0603C362G4HACTU

Aliases (C0603C362G4HAC7867) SMD Comm X8R HT150C, Ceramic, 3,600 pF, 2%, 16 VDC, X8R, SMD, MLCC, High Temperature, Ultra-Stable, 0603, 0.5 mm



General Information	
Series	SMD Comm X8R HT150C
Style	SMD Chip
Description	SMD, MLCC, High Temperature, Ultra-Stable
Features	High Temperature, Ultra-Stable
RoHS	Yes
Termination	Tin
Marking	No
AEC-Q200	No
Typical Component Weight	4.8 mg
Shelf Life	78 Weeks
MSL	1

Dimensions	
Chip Size	0603
L	1.6mm +/-0.15mm
W	0.8mm +/-0.15mm
Т	0.8mm +/-0.07mm
S	0.5mm MIN
В	0.35mm +/-0.15mm
В	0.35mm +/-0.15mm

S	0.5mm MIN
В	0.35mm +/-0.15mm
Packaging Specifications	
Packaging	T&R, 180mm, Paper Tape

4000

Packaging Quantity

Specifications	
Capacitance	3,600 pF
Measurement Condition	1 kHz 1.0Vrms
Tolerance	2%
Voltage DC	16 VDC
Dielectric Withstanding Voltage	40 VDC
Temperature Range	-55/+150°C
Temp. Coefficient	X8R
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	15%, 1kHz 1.0Vrms
Dissipation Factor	2.5% 1 kHz 1.0Vrms
Aging Rate	0% Loss/Decade Hour: Referee Time is 1000 Hours
Insulation Resistance	100 GOhms

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